



**SGS-THOMSON**  
MICROELECTRONICS

**TDA7262**

## 20+20W STEREO AMPLIFIER WITH STAND-BY

- WIDE SUPPLY VOLTAGE RANGE
- HIGH OUTPUT POWER  
28+28W TYP. MUSIC POWER  
20+20W @ THD = 10%,  $R_L = 4\Omega$ ,  $V_S = 28V$
- HIGH CURRENT CAPABILITY (UP TO 3.5A)
- STAND-BY FUNCTION
- AC SHORT CIRCUIT PROTECTION
- THERMAL OVERLOAD PROTECTION

### DESCRIPTION

The TDA7262 is class AB dual Hi-Fi Audio power amplifier assembled in Multiwatt package, specifically designed for high quality stereo application as Hi-Fi music centers and TV sets.

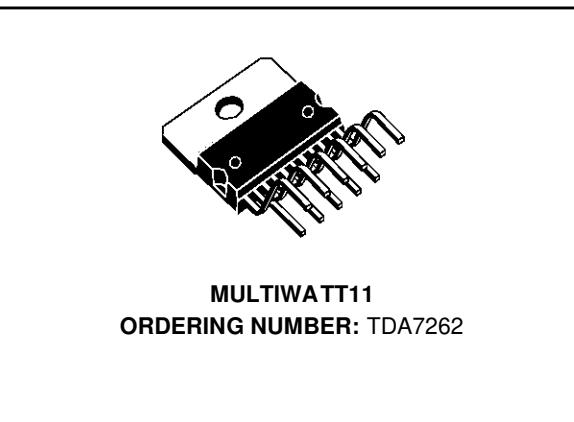
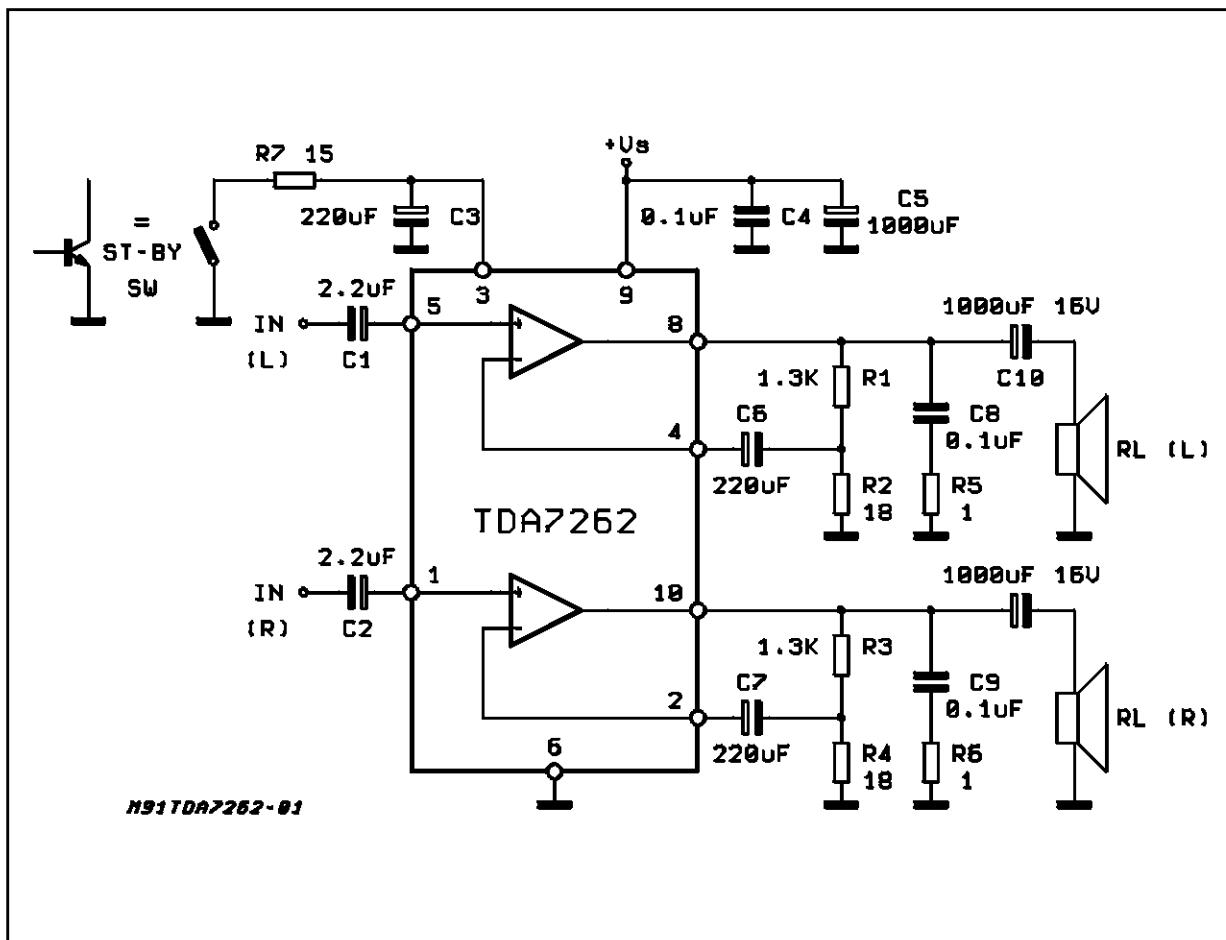


Figure 1: Stereo Application Circuit with Stand-By

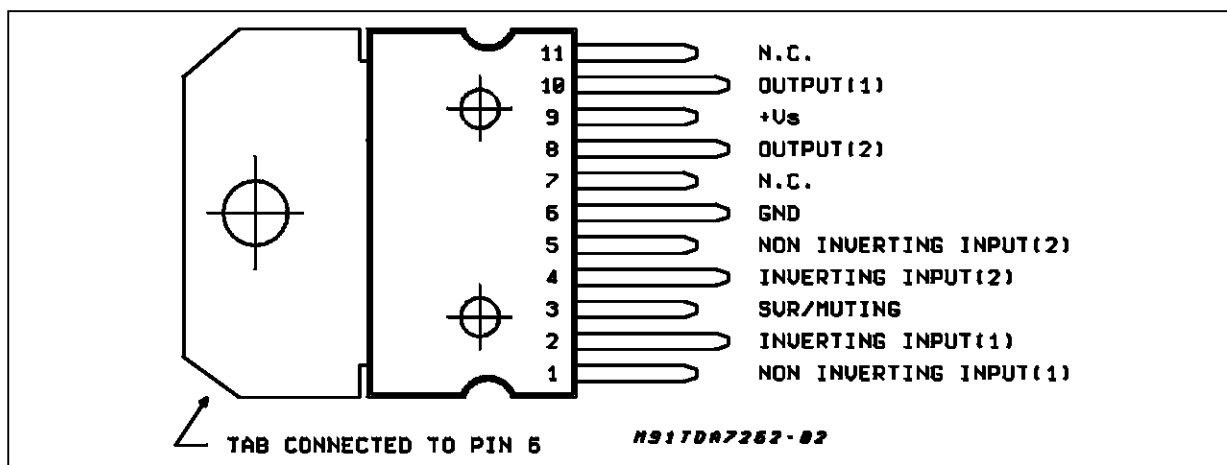


## TDA7262

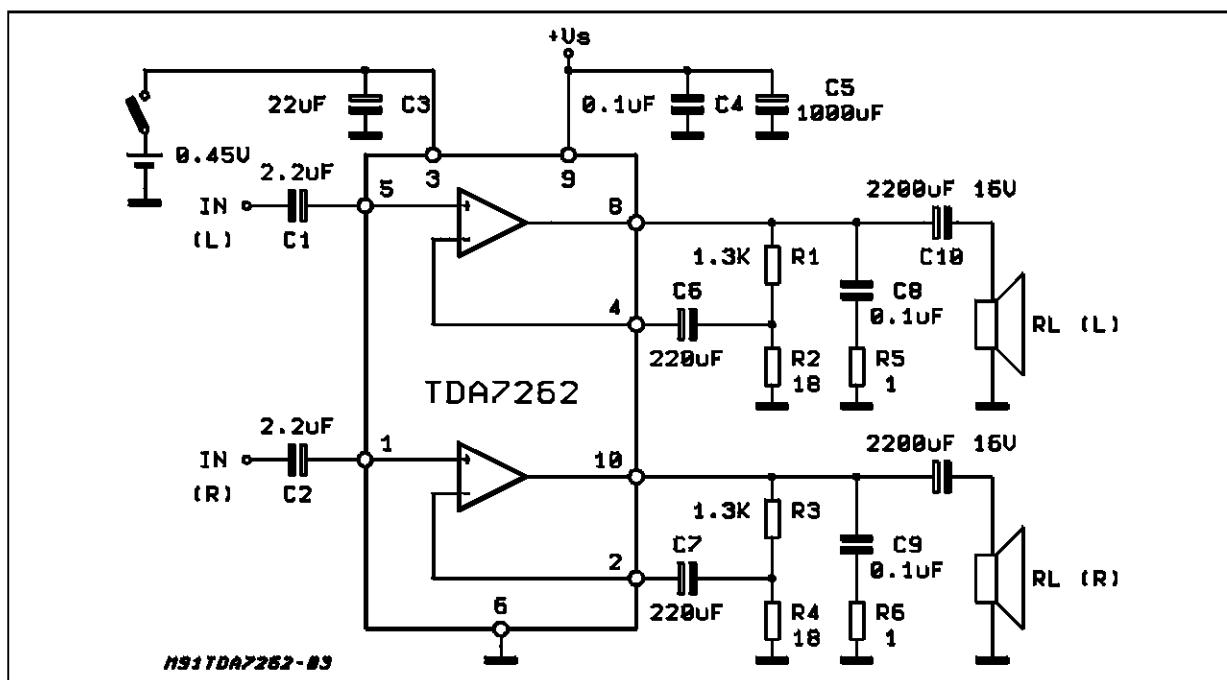
### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>S</sub>	Supply Voltage	35	V
I <sub>O</sub>	Output Peak Current (repetitive f > 20Hz)	3.5	A
I <sub>O</sub>	Output Peak Current (non repetitive, t > 100μs)	4.5	A
P <sub>tot</sub>	Power Dissipation (T <sub>case</sub> = 70°C)	30	W
T <sub>stg</sub> , T <sub>j</sub>	Storage and Junction Temperature	-40 to 150	°C

### PIN CONNECTION



### TEST CIRCUIT



**THERMAL DATA**

Symbol	Description	Value	Unit
R <sub>th j-case</sub>	Thermal Resistance Junction-case	Max	2.5 °C/W

**ELECTRICAL CHARACTERISTICS** (Refer to the stereo test circuit, V<sub>S</sub> = 28V; f = 1KHz; T<sub>amb</sub> = 25°C, unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V <sub>S</sub>	Supply Voltage		8		32	V
V <sub>O</sub>	Quiescent Output Voltage	V <sub>S</sub> = 32V		15.5		V
I <sub>d</sub>	Total Quiescent Current	V <sub>S</sub> = 28V V <sub>S</sub> = 32V		65 70	120	mA mA
P <sub>O</sub>	Output Power (each channel)	Music Power STD rules (T = 1s) V <sub>S</sub> = 32V; d = 10%; R <sub>L</sub> = 4Ω		28		W
		d = 10% R <sub>L</sub> = 4Ω R <sub>L</sub> = 8Ω	10	22 13		W W
		d = 1% R <sub>L</sub> = 4Ω R <sub>L</sub> = 8Ω		18 10		W W
d	Total Harmonic Distortion	f = 100Hz to 10KHz P <sub>O</sub> = 0.1 to 14W; R <sub>L</sub> = 4Ω P <sub>O</sub> = 0.1 to 8W; R <sub>L</sub> = 8Ω		0.2 0.1		% %
CT	Cross Talk	R <sub>L</sub> = 4Ω R <sub>S</sub> = 100Ω f = 1KHz f = 10KHz		60 50		dB dB
V <sub>i</sub>	Input Saturation Voltage	(Vrms)	300			mV
R <sub>i</sub>	Input Resistance	f = 1KHz; non inverting Input	70	200		KΩ
f <sub>L</sub>	Low Frequency roll-off (-3dB)	R <sub>L</sub> = 4Ω		40		Hz
f <sub>H</sub>	High Frequency roll-off (-3dB)	R <sub>L</sub> = 4Ω		80		KHz
G <sub>V</sub>	Closed Loop Voltage Gain	f = 1KHz	35.5	36	36.5	dB
ΔG <sub>V</sub>	Closed Loop Gain match			0.5		dB
e <sub>N</sub>	Total Input Noise Voltage	A Curve; R <sub>S</sub> = 10KΩ		1.5		μV
		f = 22Hz to 22KHz; R <sub>S</sub> = 10KΩ		2.5	8	μV
SVR	Supply Voltage Rejection (each channel)	R <sub>S</sub> = 0 to 10KΩ; f <sub>r</sub> = 100Hz V <sub>r</sub> = 0.5V		55		dB
T <sub>j</sub>	Thermal Shutdown Junction Temperature			145		°C

**STAND-BY FUNCTION**

V <sub>3</sub>	Stand-By Threshold	V <sub>S</sub> = 32V	0.45	0.9		V
A <sub>M</sub>	Stand-By Attenuation	V <sub>S</sub> = 32V; V <sub>3</sub> < 0.45V	60	100		dB
I <sub>M</sub>	Stand-By Quiescent Current	V <sub>S</sub> = 32V; V <sub>3</sub> < 0.45V		3	5	mA

### APPLICATION SUGGESTION

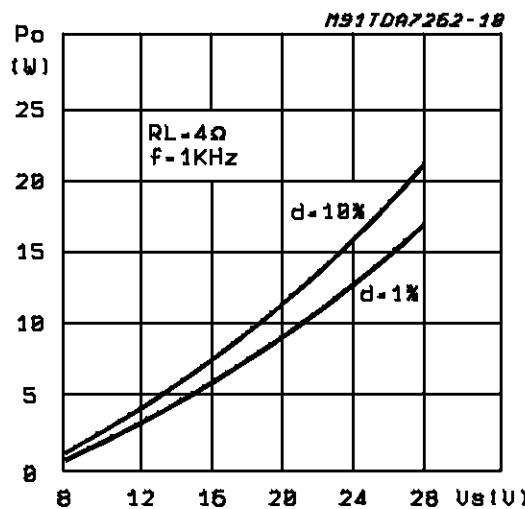
The recommended values of the components are those shown on application circuit of Figure 1. Different values can be used; the following table can help the designer.

Component	Recomm. Value	Purpose	Larger than	Smaller than
R1 and R3	1.3KΩ	Close loop gain setting (*)	Increase of gain	Decrease of gain
R2 and R4	18Ω		Decrease of gain	Increase of gain
R5 and R6	1Ω	Frequency stability	Danger of oscillations	
C1 and C2	2.2μF	Input DC decoupling	higher turn-on delay	- worse turn-ON pop - higher low freq. cutoff. Increase of noise
C3	22μF (**)	- Ripple rejection - Stand-by time constant	Increase of the Switch-on time	- Degradation of SVR - worse turn-OFF pop by stand-by
C4	100nF	Supply setting		Danger of oscillations
C5	1000μF	Supply setting		worse turn-OFF pop
C6 and C7	220μF	Feedback input DC decoupling		
C8 and C9	0.1μF	Frequency stability		Danger of oscillations
C10 and C11	1000μF to 2200μF	Output DC decoupling		Higher low-frequency cut-off

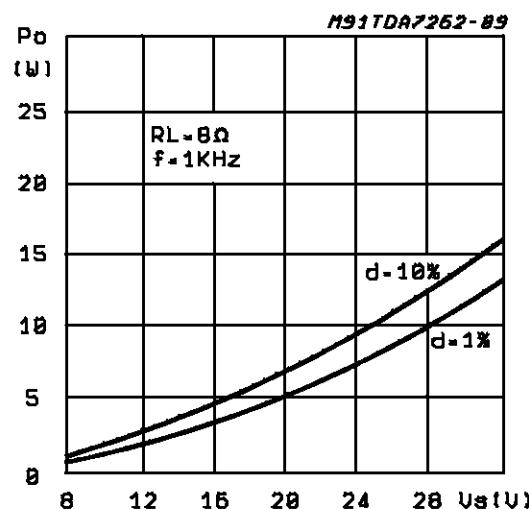
(\*) Closed loop gain must be higher than 26dB.

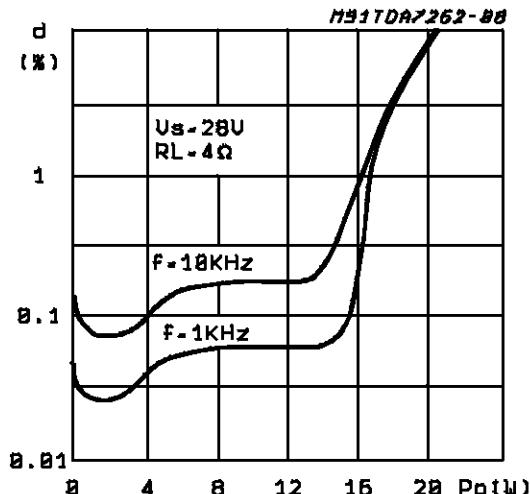
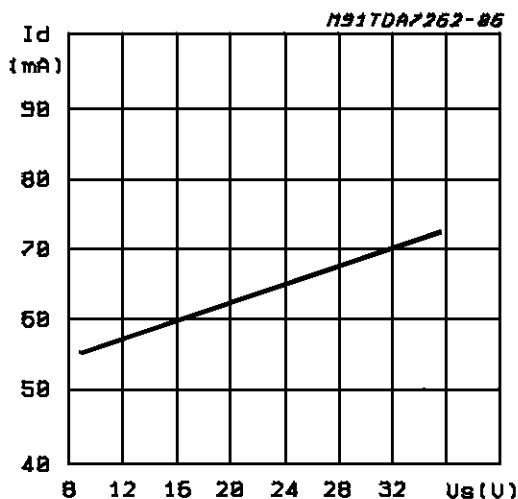
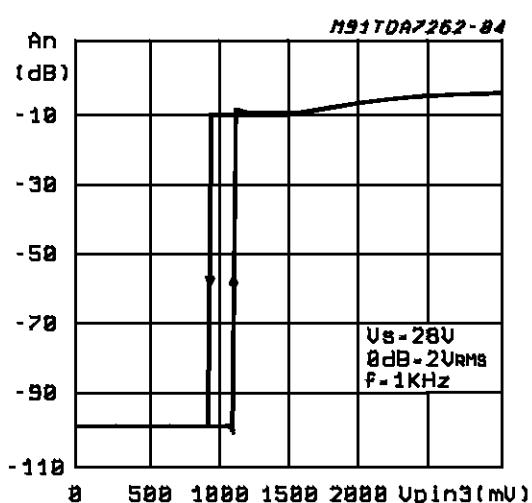
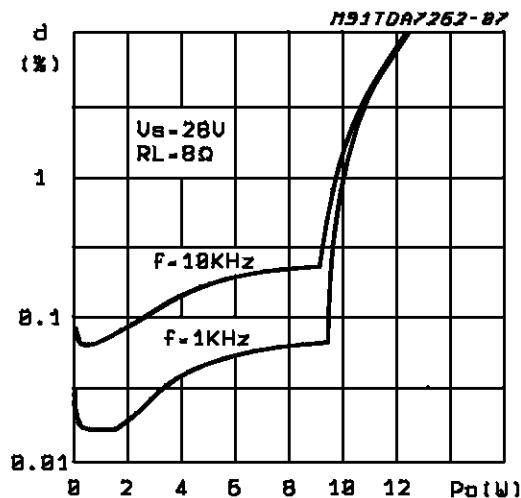
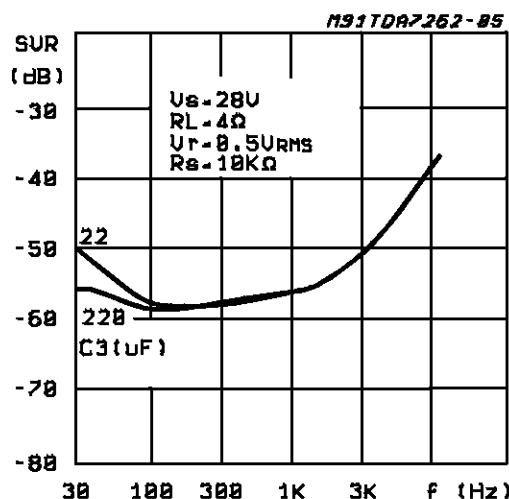
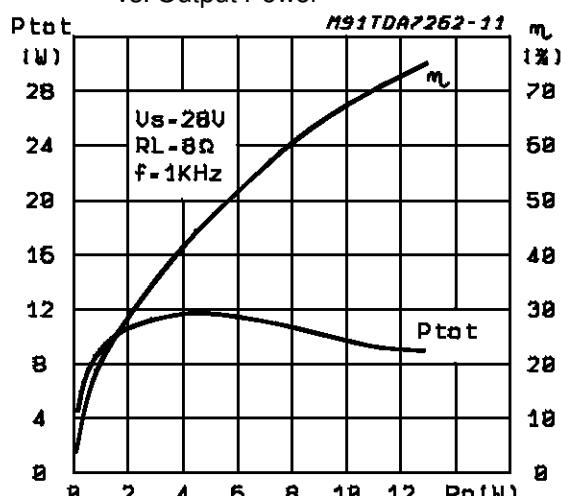
(\*\*) 220μF in case of stand-by utilization.

**Figure 2:** Output Power vs. Supply Voltage

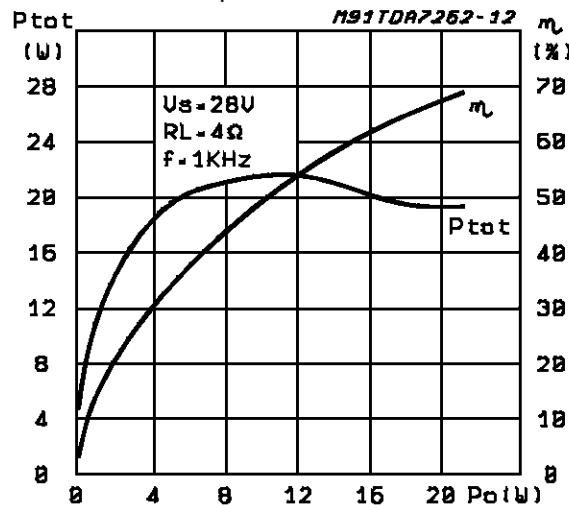


**Figure 3:** Output Power vs. Supply Voltage

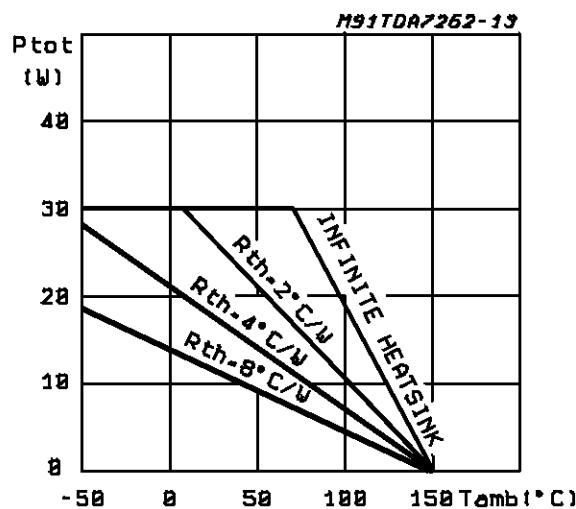


**Figure 4:** Distortion vs. Output Power**Figure 6:** Quiescent Current vs. Supply Voltage**Figure 8:** Output Attenuation vs. Vpin 3**Figure 5:** Distortion vs. Output Power**Figure 7:** Supply Voltage Rejection vs. Frequency**Figure 9:** Total Power Dissipation & Efficiency vs. Output Power

**Figure 11:** Total Power Dissipation & Efficiency vs. Output Power



**Figure 12**



## BUILD-IN PROTECTION SYSTEMS

### Thermal shut-down

The presence of a thermal limiting circuit offers the following advantages:

- 1) an overload on the output (even if it is permanent), or an excessive ambient temperature can be easily withstood.
- 2) the heatsink can have a smaller factor of safety compared with that of a conventional circuit. There is no device damage in the case of excessive junction temperature; all that happens is that  $P_o$  (and therefore  $P_{tot}$ ) and  $I_o$  are reduced. The maximum allowable power dissipation depends upon the size of the external heatsink (i.e. its thermal resistance); Figure 12 shows this dissipable power as a function of ambient temperature for different thermal resistance.

### Short circuit (AC Conditions)

The TDA7262 can withstand accidental short circuits across the speaker made by a wrong connection during normal play operation.

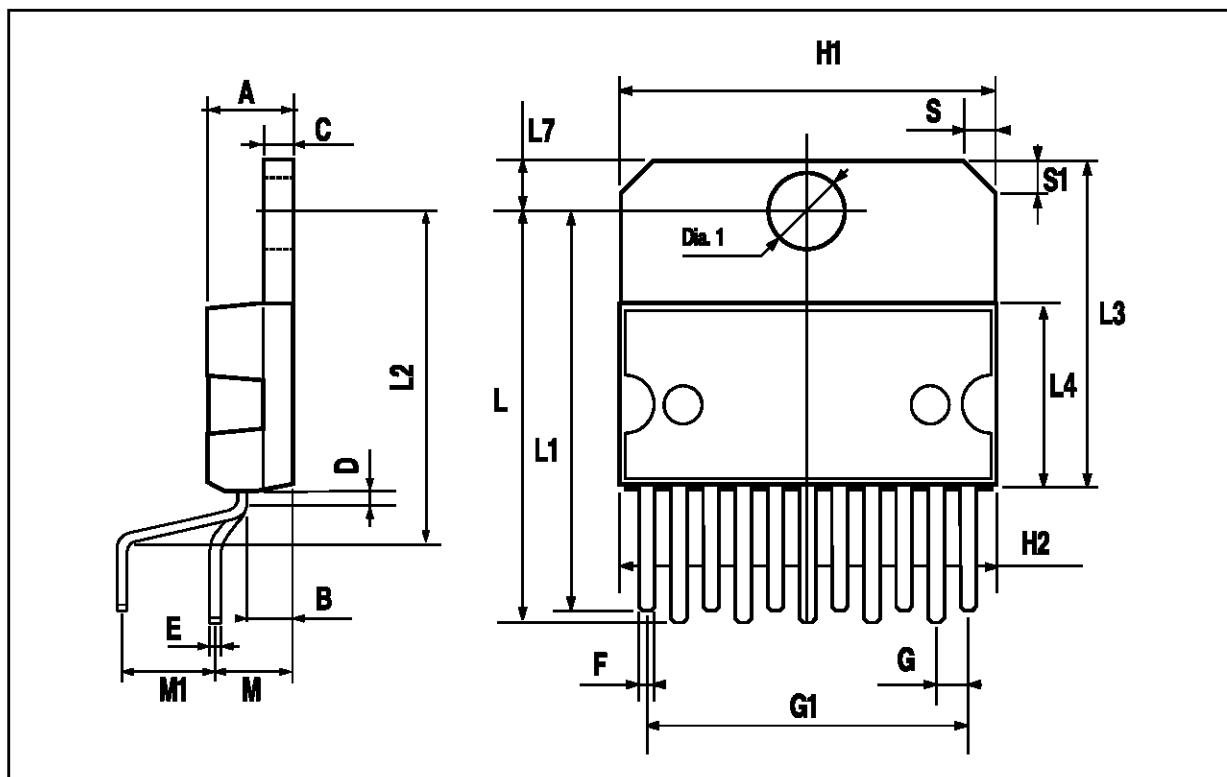
### MOUNTING INSTRUCTIONS

The power dissipated in the circuit must be removed by adding an external heatsink.

Thanks to the MULTIWATT package attaching the heatsink is very simple, a screw or a compression spring (clip) being sufficient. Between the heatsink and the package it is better to insert a layer of silicon grease, to optimize the thermal contact; no electrical isolation is needed between the two surfaces.

## MULTIWATT11 PACKAGE MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			5			0.197
B			2.65			0.104
C			1.6			0.063
D		1			0.039	
E	0.49		0.55	0.019		0.022
F	0.88		0.95	0.035		0.037
G	1.45	1.7	1.95	0.057	0.067	0.077
G1	16.75	17	17.25	0.659	0.669	0.679
H1	19.6			0.772		
H2			20.2			0.795
L	21.9	22.2	22.5	0.862	0.874	0.886
L1	21.7	22.1	22.5	0.854	0.87	0.886
L2	17.4		18.1	0.685		0.713
L3	17.25	17.5	17.75	0.679	0.689	0.699
L4	10.3	10.7	10.9	0.406	0.421	0.429
L7	2.65		2.9	0.104		0.114
M	4.25	4.55	4.85	0.167	0.179	0.191
M1	4.73	5.08	5.43	0.186	0.200	0.214
S	1.9		2.6	0.075		0.102
S1	1.9		2.6	0.075		0.102
Dia1	3.65		3.85	0.144		0.152



Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

© 1995 SGS-THOMSON Microelectronics - All Rights Reserved  
MULTIWATT® is a Registered Trademark of SGS-THOMSON Microelectronics

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands - Singapore -  
Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.

This datasheet has been download from:

[www.datasheetcatalog.com](http://www.datasheetcatalog.com)

Datasheets for electronics components.